TPS65000-Q1 Automotive Camera Power Supply

1.8V @ 600mA  FPDLink and I/O

2.8V @ 300mA  Analog Sensor

1.2V @ 300mA  Digital Core

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ASSEMBLY

Test Harness:
8 Connection Terminals: SSHL-002T-P0.2
8 26 AWG wires - 4 inches long (See Color Below)
1 Connector housing receptacle: GHR-08V-S

Variant/Label Table

<table>
<thead>
<tr>
<th>Variant</th>
<th>Label Text</th>
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<tbody>
<tr>
<td>001</td>
<td>ChangeMe!</td>
</tr>
<tr>
<td>002</td>
<td>ChangeMe!</td>
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Assembly Note
This Assembly Note will show in the PcbDoc and associated outputs
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